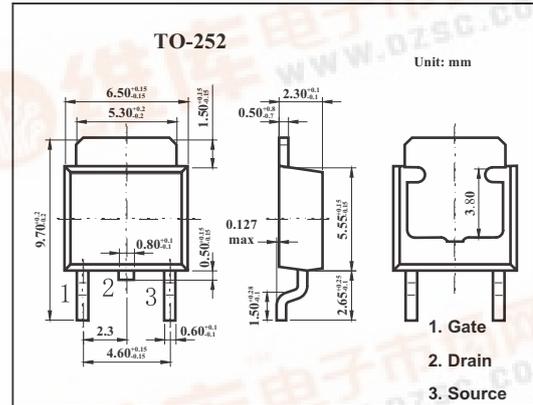


SMD Type Transistors

Small Switching
2SK3050

■ Features

- Low on-resistance.
- Fast switching speed.
- Wide SOA (safe operating area).
- Gate-source voltage (V_{GSS}) guaranteed to be ±30V.
- Easily designed drive circuits.
- Easy to use in parallel.
- Silicon N-channel MOSFET



■ Absolute Maximum Ratings Ta = 25°C

Parameter	Symbol	Rating	Unit
Drain to Source Voltage	V _{DSS}	600	V
Gate to Source Voltage	V _{GSS}	±30	V
Drain Current(DC)	I _D	2	A
Drain Current (pulse) *	I _{DP}	6	A
Body to drain diode reverse drain current	I _{DR}	2	A
Body to drain diode reverse drain current(pulse) *	I _{DRP}	6	A
Total power dissipation (Tc=25°C)	P _D	20	W
Channel Temperature	T _{ch}	150	°C
Storage temperature	T _{stg}	-55 to +150	°C

* PW≤10μs, Dduty cycle≤1%.

■ Electrical Characteristics Ta = 25°C

Parameter	Symbol	Testconditions	Min	Typ	Max	Unit
Gate to source leak current	I _{GSS}	V _{GS} =±30V, V _{DS} =0V			±100	nA
Drain to source breakdown voltage	V _{(BR)DSS}	I _D =1mA, V _{GS} =0V	600			V
Zero gate voltage drain current	I _{DSS}	V _{DS} =600V, V _{GS} =0V			100	μA
Gate threshold voltage	V _{Gsth}	V _{DS} =10V, I _D =1mA	2.0		4.0	V
Static Drain to source on statesresistance	R _{DS(on)}	I _D =1A, V _{GS} =10V		4.4	5.5	Ω
Forward transfer admittance	y _{fs}	I _D =1A, V _{DS} =10V	0.5	1.0		S
Input capacitance	C _{iss}	V _{DS} =10V		280		pF
Output capacitance	C _{oss}	V _{GS} =0V		48		pF
Reverse transfer capacitance	C _{rss}	f=1MHz		16		pF
Turn-on delay time	t _{d(on)}	V _{GS} =10V		12		ns
Rise time	t _r	R _L =300 Ω		17		ns
Turn-off delay time	t _{d(off)}	R _G =10 Ω		29		ns
Fall time	t _f	I _D =1A, V _{DD} =300V		105		ns
Reverse recovery time	t _{rr}	I _{DR} =2A, V _{GS} =0V		460		ns
Reverse recovery charge	Q _{rr}	di/dt=100A/μs		2.0		μC

